

Title (en)

ASSEMBLY FOR ELECTRICAL/ELECTRONIC COMPONENTS

Title (de)

MONTAGE ELEKTRISCHER/ELEKTRONISCHER KOMPONENTEN

Title (fr)

MONTAGE DESTINE A DES ELEMENTS ELECTRIQUES/ELECTRONIQUES

Publication

EP 1254481 A2 20021106 (EN)

Application

EP 00956698 A 20000831

Priority

- GB 0003348 W 20000831
- GB 9921307 A 19990910

Abstract (en)

[origin: GB2354116A] An assembly for electrical/electronic components 10 has one or more component carriers 6 arranged to mate with a receiving station 3 provided in a heatsink body 2 and be in thermal communication contact with the heatsink body. Electrical or electronic components 10 are carried by the component carrier and an electrical contact arrangement 11,13 for a respective component/component carrier sub-assembly, is configured for connection to an electric/electronic circuit 14. The circuit 14 may be operable in different modes depending on the nature and/or arrangement of the components 10.

IPC 1-7

H01L 23/367; H01L 23/40

IPC 8 full level

H05K 7/20 (2006.01)

CPC (source: EP)

H01L 23/367 (2013.01); **H01L 23/4006** (2013.01); **H05K 7/20509** (2013.01); **H01L 2924/0002** (2013.01)

Citation (search report)

See references of WO 0120674A2

Designated contracting state (EPC)

AT BE CH CY DE DK ES FI FR GB GR IE IT LI LU MC NL PT SE

DOCDB simple family (publication)

GB 2354116 A 20010314; **GB 2354116 B 20031203**; **GB 9921307 D0 19991110**; AU 6856500 A 20010417; EP 1254481 A2 20021106; WO 0120674 A2 20010322; WO 0120674 A3 20010927

DOCDB simple family (application)

GB 9921307 A 19990910; AU 6856500 A 20000831; EP 00956698 A 20000831; GB 0003348 W 20000831